

1. PART NO. EXPRESSION :

SCI0805LP-1N8KF

(a) (b) (c) (d) (e)(f)

(a) Series code

(b) Dimension code

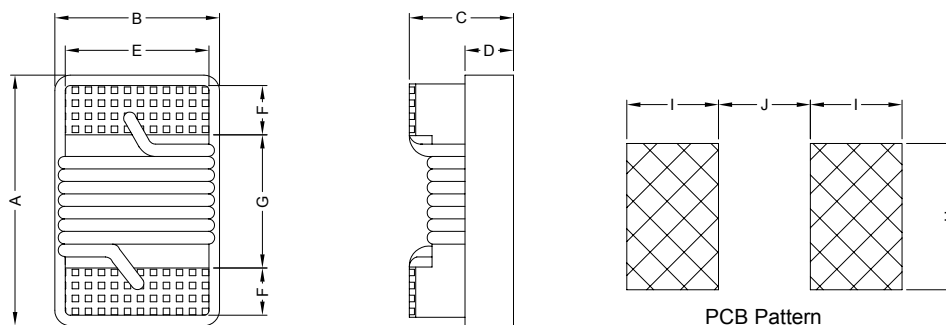
(c) Type code : LP (Low Profile)

(d) Inductance code : 1N8 = 1.8nH

(e) Tolerance code : G = $\pm 2\%$, J = $\pm 5\%$, K = $\pm 10\%$

(f) F : Lead Free

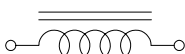
2. CONFIGURATION & DIMENSIONS :



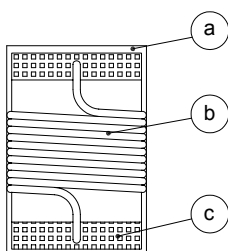
Unit:m/m

A	B	C	D	E	F	G	H	I	J
2.29 Max.	1.73 Max.	1.03 Max.	0.51 Ref.	1.27 Ref.	0.44 Ref.	1.02 Ref.	1.78 Ref.	1.02 Ref.	0.76 Ref.

3. SCHEMATIC :



4. MATERIALS :



(a) Core : Ceramic U core

(b) Wire : Enamelled Copper Wire

(c) Terminal Metallization : Ag + Ni + Au



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5. GENERAL SPECIFICATION :

- a) Storage temp. : -25°C to +80°C
- b) Operating temp. : -40°C to +125°C
- c) Temperature rise : 40°C Max.
- d) Rated current : Base on temp. rise & $\Delta L/L0A=10\%$ Max.
- e) Resistance to solder heat : 260°C.10sec

6. ELECTRICAL CHARACTERISTICS :

Part No.	Tolerance Available	L (nH)	Test Freq (MHz)	Q Min.	Q Test Freq (MHz)	SRF (MHz) Min.	DCR (Ω) Max.	IDC (mA) Max.
SCI0805LP-1N8□F	K	1.8	250	55	1500	9400	0.030	800
SCI0805LP-3N9□F	K, J	3.9	250	50	1000	6100	0.060	800
SCI0805LP-4N7□F	K, J	4.7	250	50	1000	5500	0.060	800
SCI0805LP-6N8□F	K, J	6.8	250	50	1000	5500	0.080	800
SCI0805LP-8N2□F	K, J	8.2	250	50	1000	4800	0.080	800
SCI0805LP-10N□F	K, J, G	10	250	55	750	3300	0.080	800
SCI0805LP-12N□F	K, J, G	12	250	55	750	3800	0.100	800
SCI0805LP-15N□F	K, J, G	15	250	50	500	2950	0.100	800
SCI0805LP-18N□F	K, J, G	18	250	50	500	3100	0.130	800
SCI0805LP-22N□F	K, J, G	22	250	50	500	2900	0.150	800
SCI0805LP-27N□F	K, J, G	27	250	50	500	2450	0.230	600
SCI0805LP-33N□F	K, J, G	33	250	50	500	2350	0.280	600
SCI0805LP-39N□F	K, J, G	39	250	50	500	2200	0.330	600
SCI0805LP-47N□F	K, J, G	47	200	50	500	2000	0.390	600
SCI0805LP-56N□F	K, J, G	56	200	50	500	1850	0.390	500
SCI0805LP-68N□F	K, J, G	68	200	50	500	1500	0.400	500
SCI0805LP-82N□F	K, J, G	82	150	50	500	1500	0.440	500
SCI0805LP-R10□F	K, J, G	100	150	50	500	1200	0.640	400
SCI0805LP-R12□F	K, J, G	120	150	40	250	1150	0.680	300
SCI0805LP-R15□F	K, J, G	150	150	40	250	1050	0.800	300
SCI0805LP-1R0□F	K, J, G	1000	25	16	50	80	2.000	220

Inductance tolerance :

- : G : $\pm 2\%$
- J : $\pm 5\%$
- K : $\pm 10\%$



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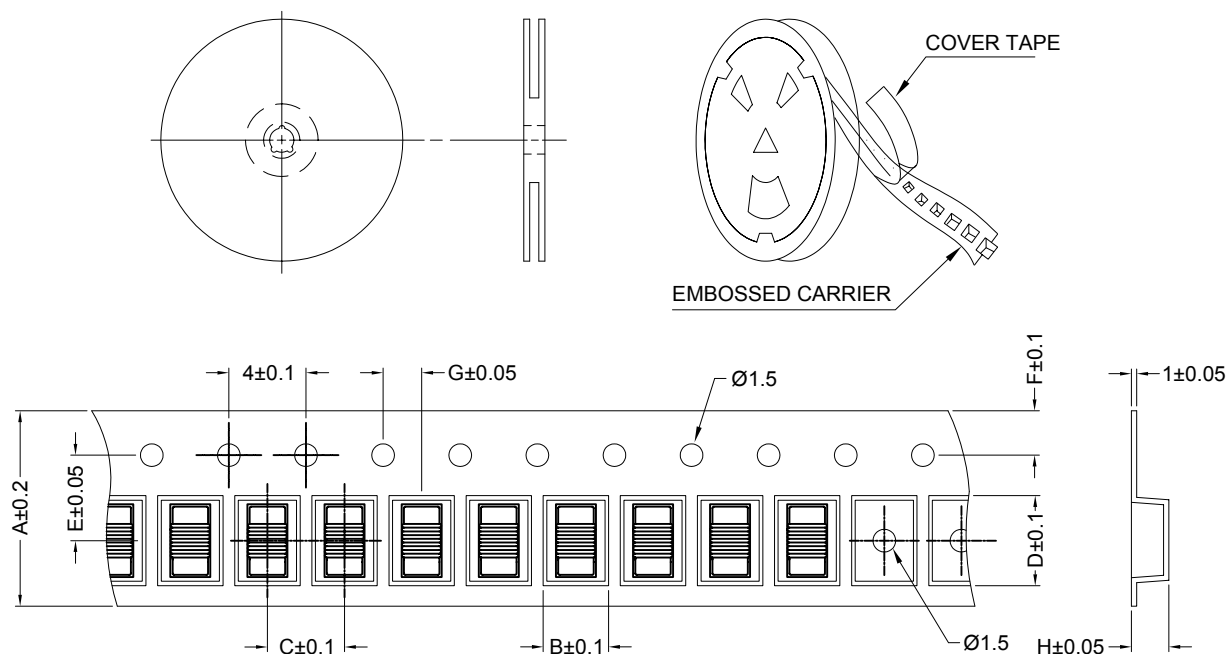
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7. PACKAGING INFORMATION :

CONFIGURATTION :



DIMENSION (unit: mm)

SERIES	A	B	C	D	E	F	G	H	I
SCI0402	8.0	0.71	2.0	1.16	3.5	1.75	0	0.65	0.23
SCI0603	8.0	1.10	4.0	1.75	3.5	1.75	2	1.15	0.25
SCI0805	8.0	1.88	4.0	2.38	3.5	1.75	2	1.48	0.20
SCI1008	8.0	2.73	4.0	2.88	3.5	1.75	2	2.33	0.20

PACKING QUANTITY

SERIES	INNER REEL
	Q'TY (PCS)
SCI0402	4000
SCI0603	4000
SCI0805	2000
SCI1008	2000



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8. ENVIRONMENTAL CHARACTERISTICS :

Electrical Performance Test :

ITEM		SPECIFICATION	TEST CONDITIONS / TEST METHODS
1	Inductance	Refer to Electrical Characteristics List	HP4291B
2	Q		HP4291B
3	SRF		HP8753D
4	DC Resistance Rdc		Mico-Ohmmeter (GOM-801G)
5	Rated Current IDC		The device should be REFLOW soldered (230±5°C for 10 seconds) to a tinned copper subs rate. A dynamiter
6	Over Load Test	After test, inductors shall have no evidence of electrical and mechanical damage	Applied 2 times of rated allowed DC current to inductor for a period of 5 minute.
7	Withstanding Voltage Test	After test, inductors shall have no evidence of electrical and mechanical damage	AC voltage of 500VAC applied between inductors terminal and case for 1 minute.
8	Insulation Resistance Test	1000 MOhm min.	100VDC applied between inductor terminal and case



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Mechanical Performance Test :

ITEM	SPECIFICATION	TEST CONDITIONS / TEST METHODS
1	Vibration Appearance : No damage L change : within $\pm 5\%$ Q change : within $\pm 10\%$	Test device shall be soldered on the substrate Oscillation Frequency : 10 to 55 to 10Hz for 1 min. Amplitude : 1.5mm Time : 2hrs for each axis (X, Y, Z), total 6hrs.
2	Resistance to Soldering Heat Appearance : No damage L change : within $\pm 5\%$ Q change : within $\pm 10\%$	Pre-heating : 150°C, 1 min Solder Composition : Sn/Pb=63/67 Solder Temperature : 230 $\pm$ 5°C Immersion Time : 20 $\pm$ 2sec Solder Temperature : 260 $\pm$ 5°C Immersion Time : 5 $\pm$ 2sec
3	Component Adhesion (Push Test) 1 lbs. For 0402 2 lbs. For 0603 3 lbs. For the rest	The device should be REFLOW soldered (230 $\pm$ 5°C for 10 seconds) to a tinned copper subs rate. A dynamiter force gauge should be applied to the side of the component. The device must withstand a minimum force of 2 or 4 pounds without a failure of the termination attached to component.
3	Component Adhesion (Push Test) The electrodes shall be at least 90% covered with new solder coating.	Pre-heating : 150°C, 1min Solder Composition : Sn/Pb=63/67 Solder Temperature : 230 $\pm$ 5°C Immersion Time : 4 $\pm$ 1sec
4	Drop Test After test, the chip inductor don't fell of broke on the P.C.Board	Drop 1 time for each face and 1 time for each corner. Total drop 10 times. Drop Height : 100cm Drop Weight : 125g
5	Solderability Test The terminal should at least be 90% covered with solder	after fluxing (alpha 100 or equiv), inductor shall be dipped in a melted solder bath at 232 $\pm$ 5°C for 5 seconds.
6	Resistance to solvent test There shall be no case of deformation change in appearance of obliteration of marking	MIL-STD202F, METHOD 215D



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Climatic Test :

ITEM		SPECIFICATION	TEST CONDITIONS / TEST METHODS														
1	Temperature Characteristics	Appearance : No damage L change : within ±10% Q change : within ±20%	-40°C ~ +125°C														
2	Humidity Resistance		Temperature : 40±2°C Relative Humidity : 90~95% Time : 96hrs ±2hrs Measured after exposure in the room condition for 2hrs														
3	Low Temperature Storage Test		Temperature : -40±2°C Time : 48±2hrs Inductors are to be tested after 1 hour at room temperature.														
4	Thermal Shock Test		One cycle : <table><tr><td>Step</td><td>Temperature (°C)</td><td>Time (min)</td></tr><tr><td>1</td><td>-25±3</td><td>30</td></tr><tr><td>2</td><td>25±2</td><td>15</td></tr><tr><td>3</td><td>85±3</td><td>30</td></tr><tr><td>4</td><td>25±2</td><td>15</td></tr></table> Total : 5 cycles	Step	Temperature (°C)	Time (min)	1	-25±3	30	2	25±2	15	3	85±3	30	4	25±2
Step	Temperature (°C)	Time (min)															
1	-25±3	30															
2	25±2	15															
3	85±3	30															
4	25±2	15															
5	High Temperature Storage Test		Temperature : 125±2°C Time : 48±2hrs Load : Allowed DC current														
6	High Temperature Load Life Test	There should be no evidence of short of open circuit.	Temperature : 85±2°C Time : 1000±12hrs Load : Allowed DC current														
7	Humidity Load Life		Temperature : 40±2°C Relative Humidity : 90~95% Time : 1000±12hrs Load : Allowed DC current														



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